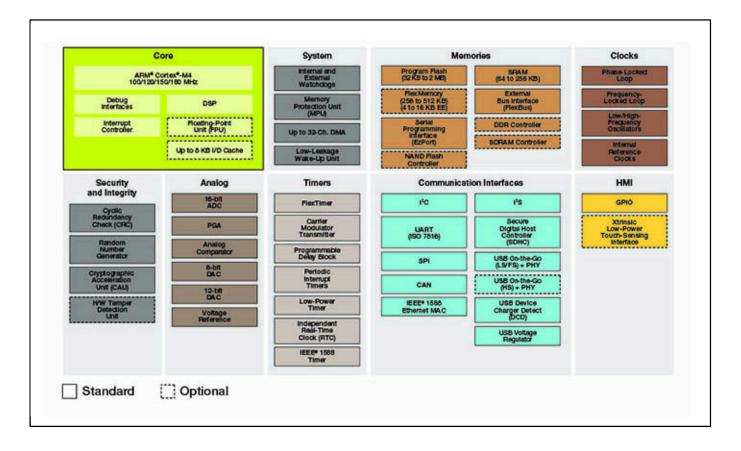


## Kinetis® K60-100 MHz, 混合信号集成微控制器,基于Arm® Cortex®-M4内核K60\_100

Last Updated: Nov 9, 2022

Kinetis® K60 100 MHz IEEE® 1588以太网MCU基于Arm® Cortex® -M4内核构建,配备先进的模拟集成和串行通信。这些器件采用低至5 mm x 5 mm的晶圆级芯片封装(WLCSP),通过极短的互连,在最大限度上节约电路板空间、增强性能,支持现有应用的微型化。该系列具备Kinetis产品组合固有的全面支持体系和可扩展性。

## Kinetis K6x MCU Family Block Diagram Block Diagram



View additional information for Kinetis® K60-100 MHz, 混合信号集成微控制器, 基于Arm® Cortex®-M4内核.

Note: The information on this document is subject to change without notice.

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